ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector−Emitter Sustaining Voltage (I_C = 30 mAdc, I_B = 0) (Note 2)	$V_{CEO(sus)}$			Vdc
TIP29G, TIP30G		40	–	
TIP29AG, TIP30AG		60	–	
TIP29BG, TIP30BG		80	–	
TIP29CG, TIP30CG		100	–	
Collector Cutoff Current (V_{CE} = 30 Vdc, I_B = 0)	I_{CEO}			mAdc
TIP29G, TIP29AG, TIP30G, TIP30AG		–	0.3	
(V_{CE} = 60 Vdc, I_B = 0)				
TIP29BG, TIP29CG, TIP30BG, TIP30CG		–	0.3	
Collector Cutoff Current (V_{CE} = 40 Vdc, V_{EB} = 0)	I_{CES}			μAdc
TIP29G, TIP30G		–	200	
(V_{CE} = 60 Vdc, V_{EB} = 0)				
TIP29AG, TIP30AG		–	200	
(V_{CE} = 80 Vdc, V_{EB} = 0)				
TIP29BG, TIP30BG		–	200	
(V_{CE} = 100 Vdc, V_{EB} = 0)				
TIP29CG, TIP30CG		–	200	
Emitter Cutoff Current (V_{BE} = 5.0 Vdc, I_C = 0)	I_{EBO}	–	1.0	mAdc
ON CHARACTERISTICS (Note 2)				
DC Current Gain	h_{FE}			–
(I_C = 0.2 Adc, V_{CE} = 4.0 Vdc)		40	–	
(I_C = 1.0 Adc, V_{CE} = 4.0 Vdc)		15	75	
Collector−Emitter Saturation Voltage (I_C = 1.0 Adc, I_B = 125 mAdc)	$V_{CE(sat)}$	–	0.7	Vdc
Base−Emitter On Voltage (I_C = 1.0 Adc, V_{CE} = 4.0 Vdc)	$V_{BE(on)}$	–	1.3	Vdc
DYNAMIC CHARACTERISTICS				
Current−Gain − Bandwidth Product (Note 3) (I_C = 200 mAdc, V_{CE} = 10 Vdc, f_{test} = 1.0 MHz)	f_T	3.0	–	MHz
Small−Signal Current Gain (I_C = 0.2 Adc, V_{CE} = 10 Vdc, f = 1.0 kHz)	h_{fe}	20	–	–

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%
3. $f_T = |h_{fe}| \bullet f_{test}$

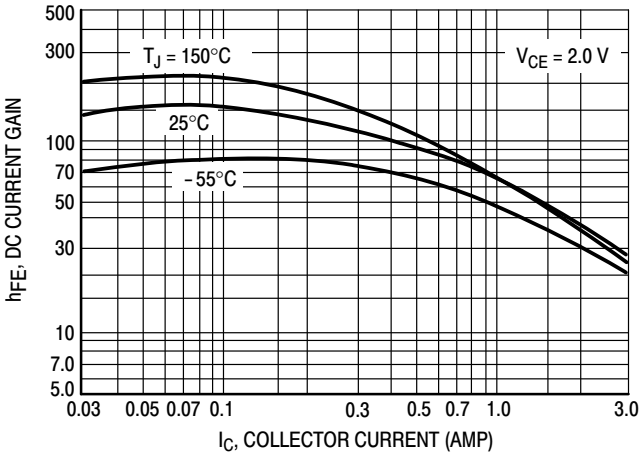


Figure 1. DC Current Gain

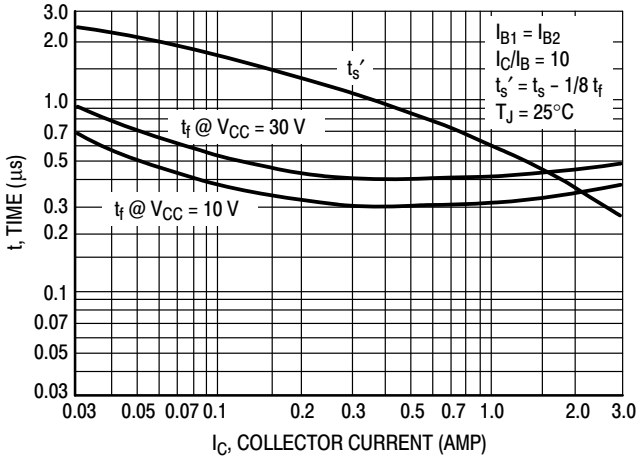


Figure 2. Turn−Off Time

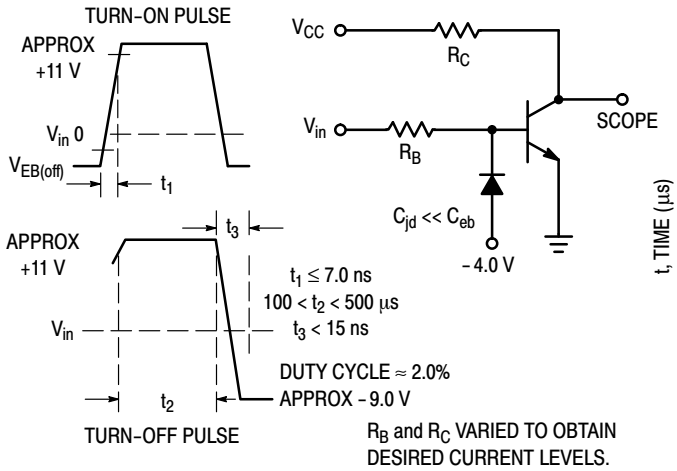


Figure 3. Switching Time Equivalent Circuit

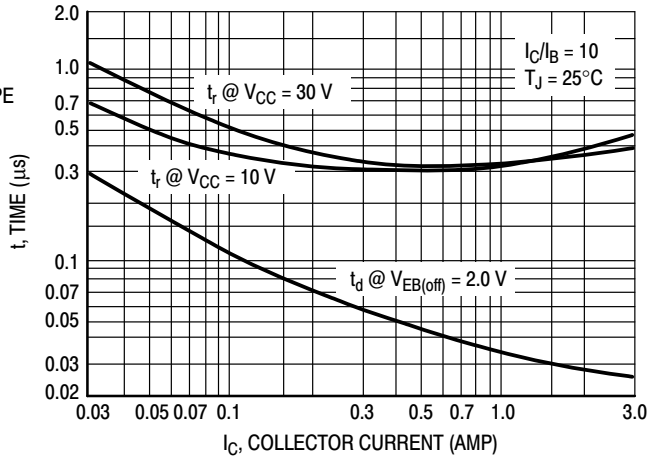


Figure 4. Turn−On Time

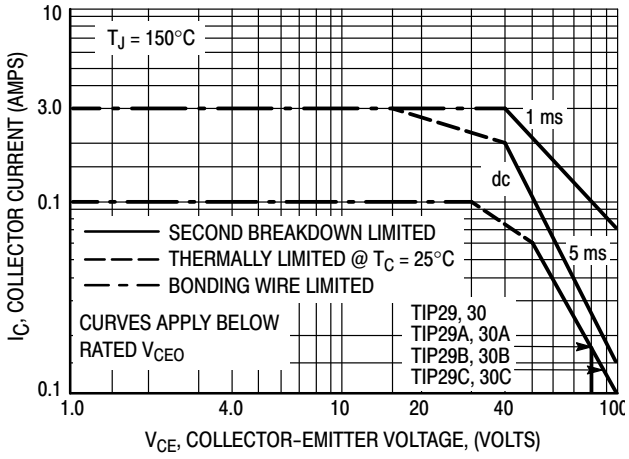


Figure 5. Active Region Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 5 is based on $T_{J(pk)}$ = 150°C; T_C is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \le 150°C$. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

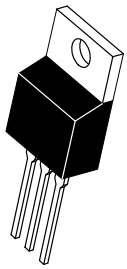
ORDERING INFORMATION

Device	Package	Shipping
TIP29G	TO−220 (Pb−Free)	50 Units / Rail
TIP29AG	TO−220 (Pb−Free)	50 Units / Rail
TIP29BG	TO−220 (Pb−Free)	50 Units / Rail
TIP29CG	TO−220 (Pb−Free)	50 Units / Rail
TIP30G	TO−220 (Pb−Free)	50 Units / Rail
TIP30AG	TO−220 (Pb−Free)	50 Units / Rail
TIP30BG	TO−220 (Pb−Free)	50 Units / Rail
TIP30CG	TO−220 (Pb−Free)	50 Units / Rail

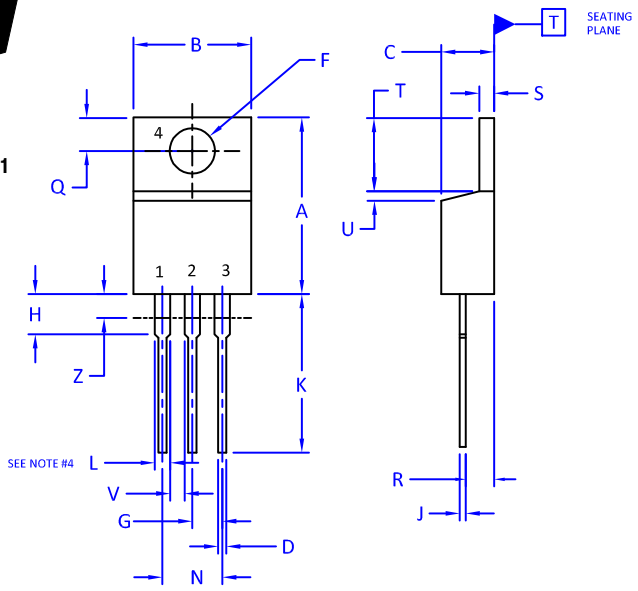
MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS

TO−220
CASE 221A
ISSUE AK

DATE 13 JAN 2022



SCALE 1:1



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 2009.
2. CONTROLLING DIMENSION: INCHES
3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.
4. MAX WIDTH FOR F102 DEVICE = 1.35MM

	INCHES		MILLIMETERS	
DIM	MIN.	MAX.	MIN.	MAX.
A	0.570	0.620	14.48	15.75
B	0.380	0.415	9.66	10.53
C	0.160	0.190	4.07	4.83
D	0.025	0.038	0.64	0.96
F	0.142	0.161	3.60	4.09
G	0.095	0.105	2.42	2.66
H	0.110	0.161	2.80	4.10
J	0.014	0.024	0.36	0.61
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.41
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045	----	1.15	---
Z	----	0.080	---	2.04

STYLE 1:
PIN 1. BASE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

STYLE 2:
PIN 1. BASE
2. EMITTER
3. COLLECTOR
4. EMITTER

STYLE 3:
PIN 1. CATHODE
2. ANODE
3. GATE
4. ANODE

STYLE 4:
PIN 1. MAIN TERMINAL 1
2. MAIN TERMINAL 2
3. GATE
4. MAIN TERMINAL 2

STYLE 5:
PIN 1. GATE
2. DRAIN
3. SOURCE
4. DRAIN

STYLE 6:
PIN 1. ANODE
2. CATHODE
3. ANODE
4. CATHODE

STYLE 7:
PIN 1. CATHODE
2. ANODE
3. CATHODE
4. ANODE

STYLE 8:
PIN 1. CATHODE
2. ANODE
3. EXTERNAL TRIP/DELAY
4. ANODE

STYLE 9:
PIN 1. GATE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

STYLE 10:
PIN 1. GATE
2. SOURCE
3. DRAIN
4. SOURCE

STYLE 11:
PIN 1. DRAIN
2. SOURCE
3. GATE
4. SOURCE

STYLE 12:
PIN 1. MAIN TERMINAL 1
2. MAIN TERMINAL 2
3. GATE
4. NOT CONNECTED

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